

Title (en)  
POLYCRYSTALLINE SIC MOLDED BODY

Title (de)  
POLYKRISTALLINER SIC-GEFORMTER KÖRPER

Title (fr)  
CORPS MOULÉ EN SIC POLYCRISTALLIN

Publication  
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Application  
**EP 20868292 A 20200925**

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Abstract (en)  
A polycrystalline SiC molded body according to the present invention has a resistivity of 0.050 Qcm or less, while having a residual stress of 120 MPa or less as determined by an X-ray diffraction method.

IPC 8 full level  
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DOCDB simple family (publication)  
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